

The listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Canceled)

2. (Currently Amended) A film-like article comprising:

a thin film integrated circuit capable of storing information described on the film-like article; and

an antenna connected to the thin film integrated circuit,

wherein the thin film integrated circuit is mounted inside the film-like article,

[[and]]

wherein the antenna is mounted on a surface of the film-like article, and [I.]

wherein the antenna is electrically connected to the thin film integrated circuit
through an opening of the film-like article.

3. (Canceled)

4. (Currently Amended) A film-like article according to Claim 2,

wherein when [[the]] a thickness of the film-like article is D, a position to dispose the thin film integrated circuit X may be set so as to satisfy $(1/2)\cdot D - 30 \mu\text{m} < X < (1/2)\cdot D + 30 \mu\text{m}$.

5. (Currently Amended) A film-like article comprising:

a IDF chip;

a thin film integrated circuit capable of storing information described on the film-like article; and

an antenna connected to the IDF chip through an anisotropic conductor; and the thin film-integrated-circuit;

a resin covering the IDF chip and the antenna,

wherein the IDF chip and the antenna are provided in a depression of the film-like article.

wherein the thin film integrated-circuit and the antenna are mounted on a surface of the film-like article.

6. (Currently Amended) A film-like article comprising:

a thin film integrated circuit capable of storing information described on the film-like article; and

an antenna connected to the thin film integrated circuit,

wherein the thin film integrated circuit is mounted on a surface of the film-like article, [[and]]

wherein the antenna is mounted inside the film-like article, and [.]

wherein the antenna is electrically connected to the thin film integrated circuit through an opening of the film-like article.

7.-13. (Canceled)

14. (Original) A film-like article according Claim 2,

wherein the thin film integrated circuit has light-transmitting characteristic.

15. (Original) A film-like article according Claim 5,

wherein the thin film integrated circuit has light-transmitting characteristic.

16. (Original) A film-like article according Claim 6,
wherein the thin film integrated circuit has light-transmitting characteristic.

17.-18. (Canceled)

19. (Original) A film-like article according to Claim 2,
wherein the thin film integrated circuit has an insulating film containing nitrogen.

20. (Original) A film-like article according to Claim 5,
wherein the thin film integrated circuit has an insulating film containing nitrogen.

21. (Original) A film-like article according to Claim 6,
wherein the thin film integrated circuit has an insulating film containing nitrogen.

22.-23. (Canceled)

24. (Original) A film-like article according to Claim 2,
wherein thickness of the thin film integrated circuit is in a range of 0.1 μm to 3
 μm .

25. (Original) A film-like article according to Claim 5,
wherein thickness of the thin film integrated circuit is in a range of 0.1 μm to 3
 μm .

26. (Original) A film-like article according to Claim 6,
wherein thickness of the thin film integrated circuit is in a range of 0.1 μm to 3
 μm .

27.-28. (Canceled)

29. (Original) A film-like article according to Claim 2,
wherein the thin film integrated circuit has a semiconductor film containing
hydrogen of 1×10^{19} atoms/cm³ to 5×10^{20} atoms/cm³.

30. (Original) A film-like article according to Claim 5,
wherein the thin film integrated circuit has a semiconductor film containing
hydrogen of 1×10^{19} atoms/cm³ to 5×10^{20} atoms/cm³.

31. (Original) A film-like article according to Claim 6,
wherein the thin film integrated circuit has a semiconductor film containing
hydrogen of 1×10^{19} atoms/cm³ to 5×10^{20} atoms/cm³.

32. (Canceled)

33. (Previously Presented) A film-like article according to any one of Claims 29
to 31,

wherein the semiconductor film includes a source, a drain, and a channel region,
and

the source, the drain, and the channel region are provided perpendicular to
direction of bending the film-like article.

34. (Canceled)

35. (Original) A film-like article according to Claim 2,
wherein the film-like article comprises a plurality of thin film integrated circuits,
and

the plurality of thin film integrated circuits are integrated with antennas.

36. (Original) A film-like article according to Claim 5,

wherein the film-like article comprises a plurality of thin film integrated circuits,

and

the plurality of thin film integrated circuits are integrated with antennas.

37. (Original) A film-like article according to Claim 6,

wherein the film-like article comprises a plurality of thin film integrated circuits,

and

the plurality of thin film integrated circuits are integrated with antennas.

38.-39. (Canceled)

40. (Original) A film-like article according to Claim 2,

wherein the film-like article is a business card.

41. (Original) A film-like article according to Claim 5,

wherein the film-like article is a business card.

42. (Original) A film-like article according to Claim 6,

wherein the film-like article is a business card.

43.-48. (Canceled)